



DPAM-23-07.0-S-3-2 Information

Heisener.com

For Reference Only

Part Number DPAM-23-07.0-S-3-2

Manufacturer Samtec Inc.

Category Connectors, Interconnects

Rectangular Connectors - Arrays, Edge Type,

Mezzanine (Board to Board)

Description .085 PITCH ELEVATED DP TERMINAL

Package -

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









DPAM-23-07.0-S-3-2 Specifications

Manufacturer Part Number	DPAM-23-07.0-S-3-2	
Manufacturer	Samtec Inc.	
Category	Connectors, Interconnects	
	Rectangular Connectors - Arrays, Edge Type, Mezzanine (Board to Board)	
Package	-	
Series	DP Array? DPAM	
Connector Type	Differential Pair Array, Male	
Number of Positions	126 Signal (63 Pair)	
Pitch	0.085" (2.16mm)	
Number of Rows	3	
Mounting Type	Surface Mount	
Features	-	
Contact Finish	Gold	
Contact Finish Thickness	30μin (0.76μm)	
Mated Stacking Heights	10mm	
Height Above Board	0.262" (6.66mm)	
		Report errors?

DPAM-23-07.0-S-3-2 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

DPAM-23-07.0-S-3-2 Payment Methods



















DPAM-23-07.0-S-3-2 Shipping Methods













If you have any question about DPAM-23-07.0-S-3-2, please do not hesitate to contact us!

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